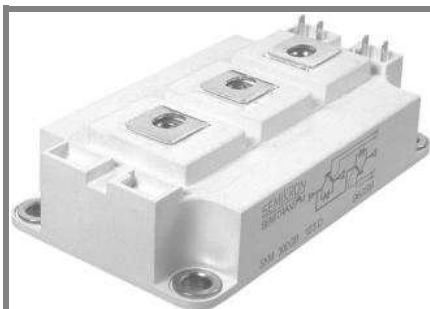




SEMITRANS® 3

Superfast IGBT Modules

SKM 300GB063D

SKM 300GAR063D

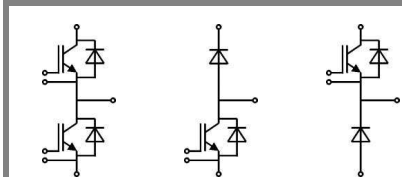
SKM 300GAL063D

Features

- NPT- Non punch-through IGBT
- Low tail current with low temperature dependence
- High short circuit capability, self limiting if term. G is clamped to E
- Pos. temp.-coeff. of V_{CEsat}
- 50 % less turn off losses
- 30 % less short circuit current
- Very low C_{ies} , C_{oes} , C_{res}
- Latch-up free
- Fast & soft inverse CAL diodes
- Isolated copper baseplate using DCB Direct Copper Bonding Technology without hard mould
- Large clearance (13 mm) and creepage distances (20 mm)

Typical Applications*

- Switching (not for linear use)
- Switched mode power supplies
- AC inverter servo drives
- UPS uninterruptable power supplies
- Welding inverters



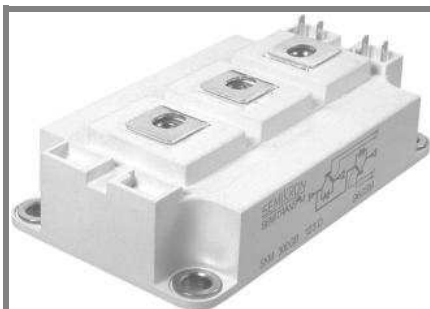
GB

GAL

GAR

Absolute Maximum Ratings				$T_c = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions			Values	Units
IGBT					
V_{CES}	$T_j = 25^\circ\text{C}$			600	V
I_C	$T_j = 150^\circ\text{C}$	$T_{case} = 25^\circ\text{C}$		400	A
		$T_{case} = 70^\circ\text{C}$		300	A
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$			600	A
V_{GES}				± 20	V
t_{psc}	$V_{CC} = 300\text{ V}; V_{GE} \leq 20\text{ V}; T_j = 125^\circ\text{C}$ $V_{CES} < 600\text{ V}$			10	μs
Inverse Diode					
I_F	$T_j = 150^\circ\text{C}$	$T_{case} = 25^\circ\text{C}$		250	A
		$T_{case} = 80^\circ\text{C}$		170	A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$			600	A
I_{FSM}	$t_p = 10\text{ ms; sin.}$	$T_j = 150^\circ\text{C}$		1600	A
Freewheeling Diode					
I_F	$T_j = 150^\circ\text{C}$	$T_c = 25^\circ\text{C}$		400	A
		$T_c = 80^\circ\text{C}$		270	A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$			800	A
I_{FSM}	$t_p = 10\text{ ms; sin.}$	$T_j = 150^\circ\text{C}$		2800	A
Module					
$I_{t(RMS)}$				500	A
T_{vj}				- 40 ... + 150	$^\circ\text{C}$
T_{stg}				- 40 ... + 125	$^\circ\text{C}$
V_{isol}	AC, 1 min.			2500	V

Characteristics			T _c = 25 °C, unless otherwise specified			
Symbol	Conditions		min.	typ.	max.	Units
IGBT						
V _{GE(th)}	V _{GE} = V _{CE} , I _C = 6 mA		4,5	5,5	6,5	V
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES}	T _j = 25 °C		0,2	0,6	mA
V _{CE0}		T _j = 25 °C		1,05		V
		T _j = 125 °C		1		V
r _{CE}	V _{GE} = 15 V	T _j = 25°C		3,2		mΩ
		T _j = 125°C		4,7		mΩ
V _{CE(sat)}	I _{Cnom} = 300 A, V _{GE} = 15 V	T _j = 25°C _{chiplev.}		2,1	2,5	V
		T _j = 125°C _{chiplev.}		2,4	2,8	V
C _{ies}	V _{CE} = 25, V _{GE} = 0 V	f = 1 MHz		17		nF
C _{oes}				2		nF
C _{res}				1,2		nF
Q _G	V _{GE} = 0V...+15V			720		nC
R _{Gint}	T _j = °C			0		Ω
t _{d(on)}	R _{Gon} = 6 Ω	V _{CC} = 300V I _C = 300A T _j = 125 °C V _{GE} = ± 15V		160		ns
t _r				80		ns
E _{on}				14		mJ
t _{d(off)}	R _{Goff} = 6 Ω			550		ns
t _f				50		ns
E _{off}			13		mJ	
R _{th(j-c)}	per IGBT				0,09	K/W



SEMITRANS® 3

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SKM 300GB063D

SKM 300GAR063D

SKM 300GAL063D

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- High short circuit capability, self limiting if term. G is clamped to E
- Pos. temp.-coeff. of V_{CEsat}
- 50 % less turn off losses
- 30 % less short circuit current
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- Latch-up free
- Fast & soft inverse CAL diodes
- Isolated copper baseplate using DCB Direct Copper Bonding Technology without hard mould
- Large clearance (13 mm) and creepage distances (20 mm)

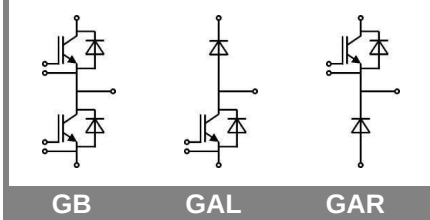
Typical Applications*

- Switching (not for linear use)
- Switched mode power supplies
- AC inverter servo drives
- UPS uninterruptable power supplies
- Welding inverters

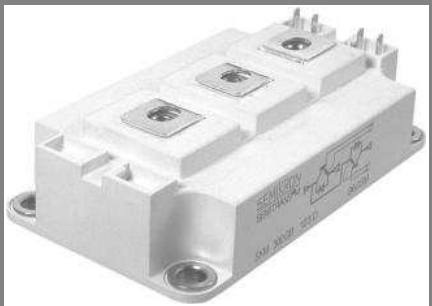
Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 300 \text{ A}; V_{GE} = 0 \text{ V}$	$T_j = 25^\circ\text{C}_{chiplev.}$	1,65	2	V
		$T_j = 125^\circ\text{C}_{chiplev.}$	1,65	2	V
V_{F0}		$T_j = 125^\circ\text{C}$		0,9	V
r_F		$T_j = 125^\circ\text{C}$	3	3,7	mΩ
I_{RRM}	$I_F = 300 \text{ A}$	$T_j = 125^\circ\text{C}$	120		A
Q_{rr}			18		μC
E_{rr}	$V_{GE} = -15 \text{ V}; V_{CC} = 300 \text{ V}$				mJ
$R_{th(j-c)D}$	per diode			0,25	K/W
Freewheeling Diode					
$V_F = V_{EC}$	$I_{Fnom} = 400 \text{ A}; V_{GE} = 0 \text{ V}$	$T_j = 25^\circ\text{C}_{chiplev.}$	1,65	2	V
		$T_j = 125^\circ\text{C}_{chiplev.}$	1,65	2	V
V_{F0}		$T_j = 125^\circ\text{C}$		0,9	V
r_F		$T_j = 125^\circ\text{C}$		3	V
I_{RRM}	$I_F = 300 \text{ A}$	$T_j = 125^\circ\text{C}$	130		A
Q_{rr}			23		μC
E_{rr}	$V_{GE} = -15 \text{ V}; V_{CC} = 300 \text{ V}$				mJ
$R_{th(j-c)FD}$	per diode			0,15	K/W
Module					
L_{CE}			15	20	nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25^\circ\text{C}$	0,35		mΩ
		$T_{case} = 125^\circ\text{C}$	0,5		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
M_s	to heat sink M6		3	5	Nm
M_t	to terminals M6		2,5	5	Nm
w				325	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.



SKM 300GB063D



SEMITRANS® 3

Superfast IGBT Modules

SKM 300GB063D
SKM 300GAR063D
SKM 300GAL063D

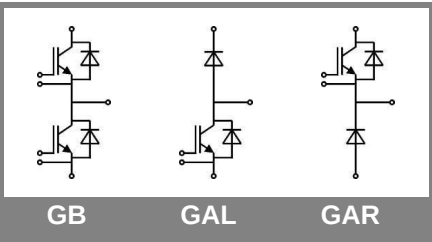
Features

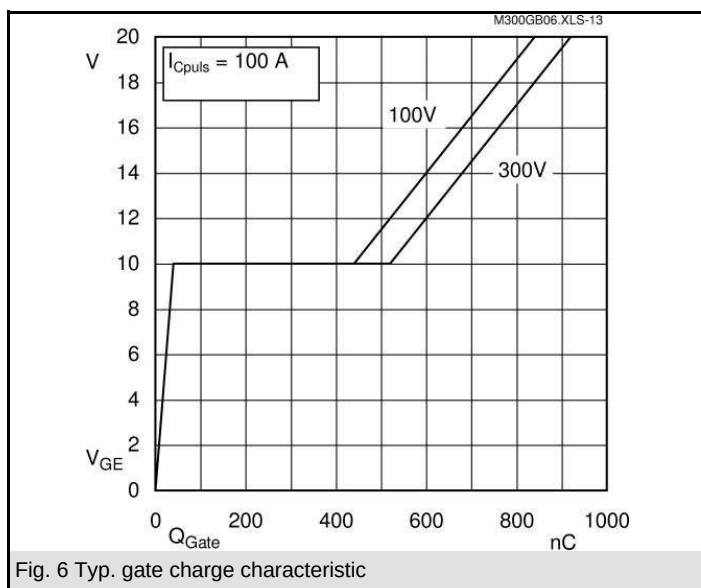
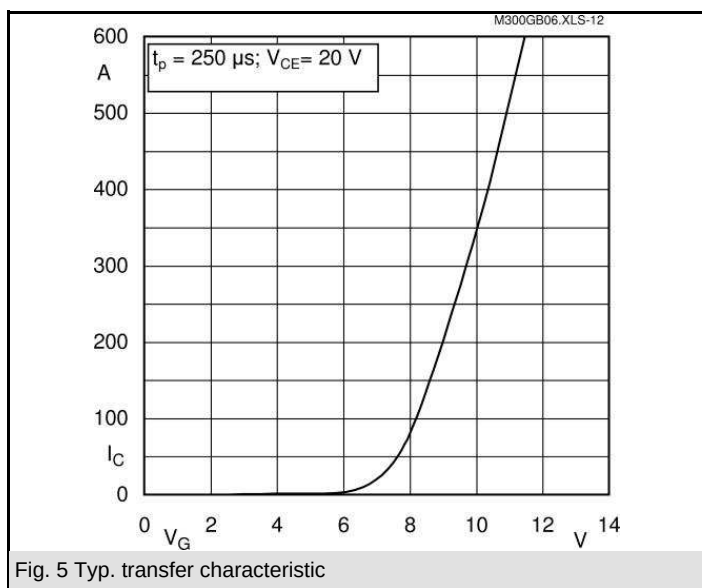
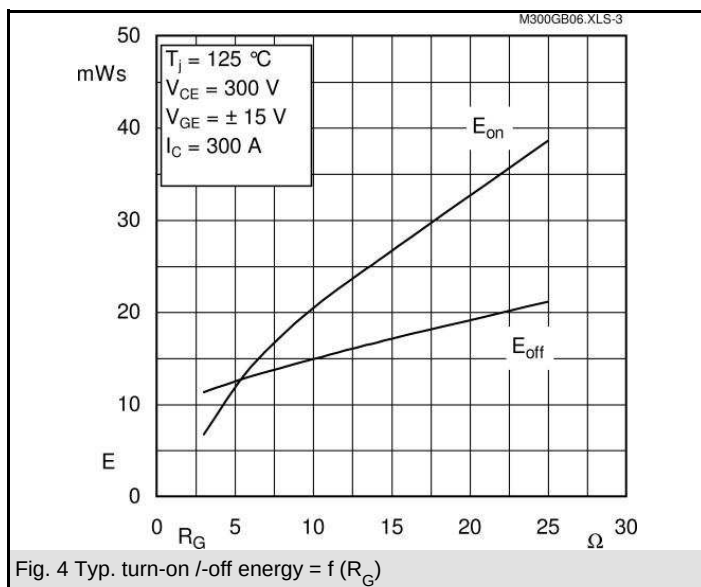
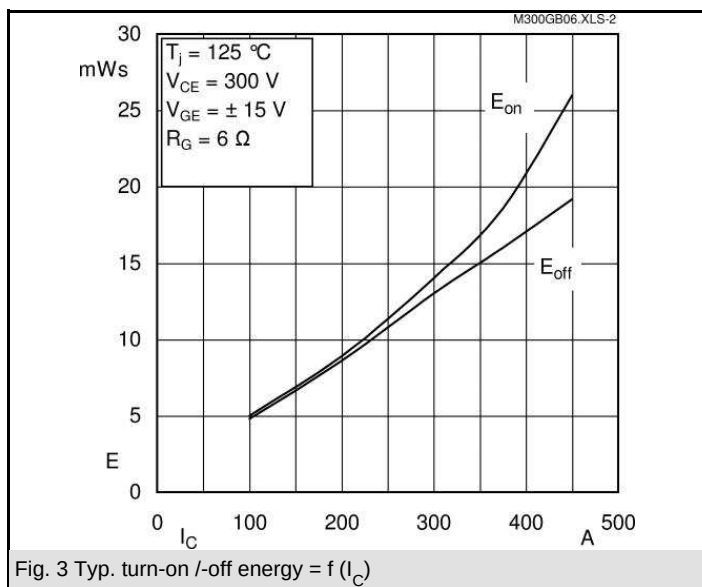
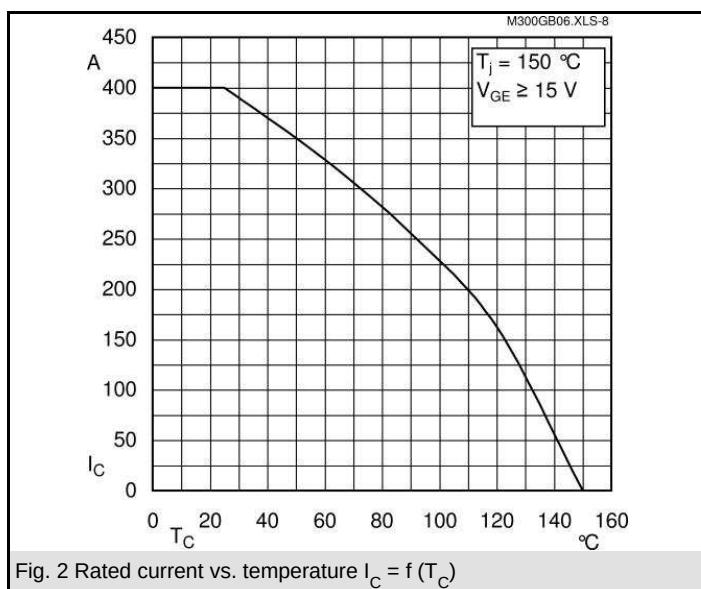
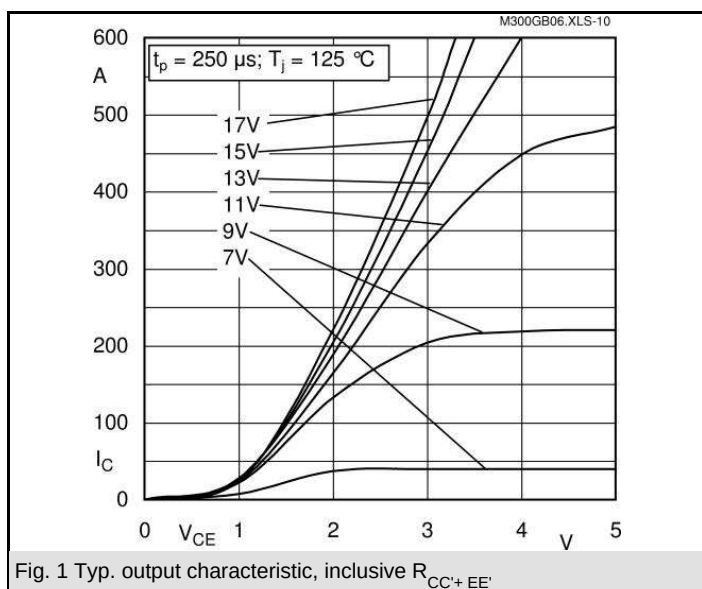
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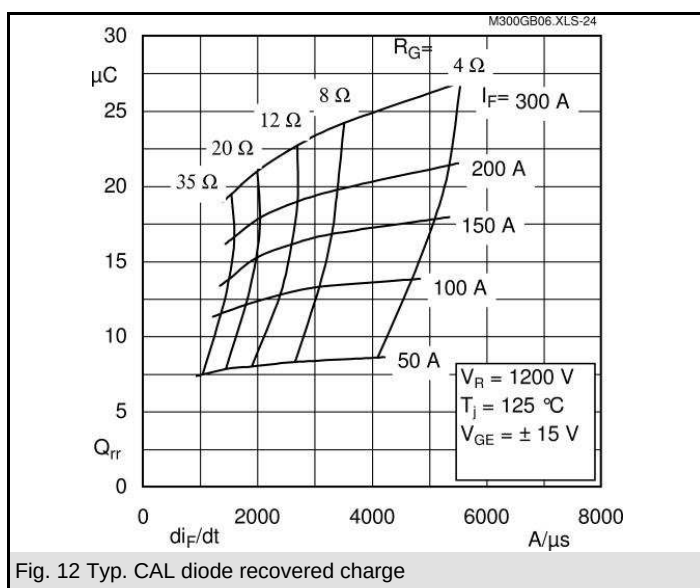
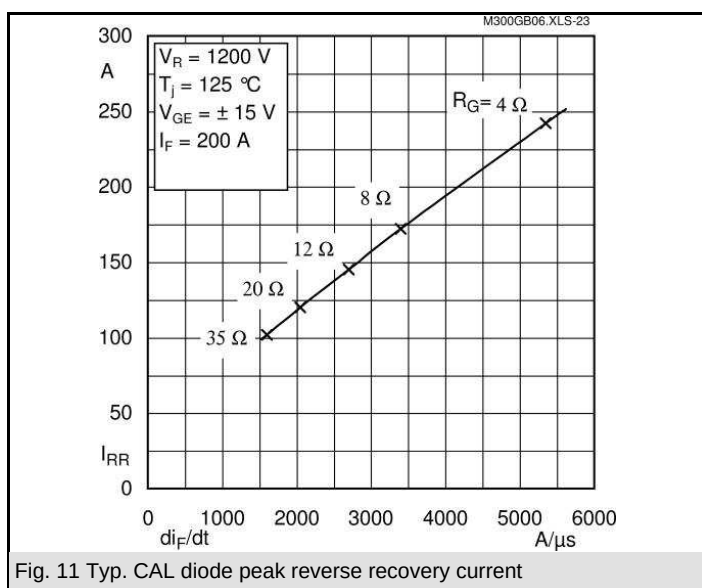
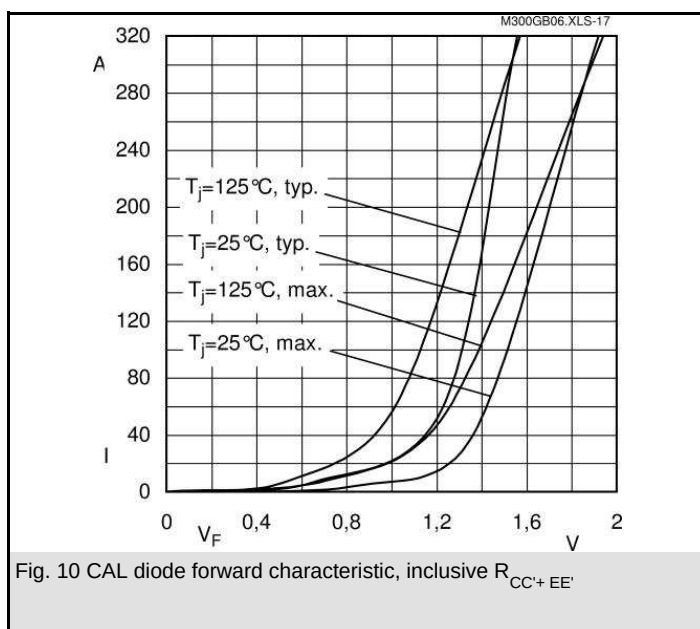
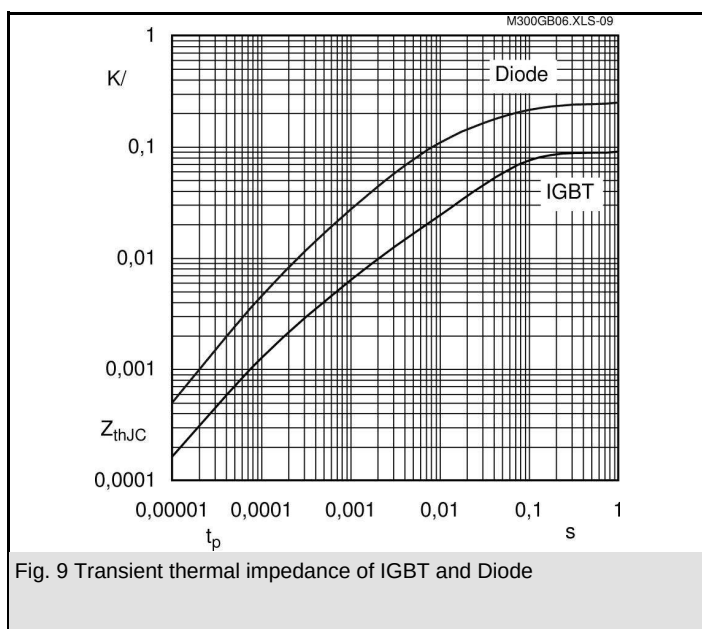
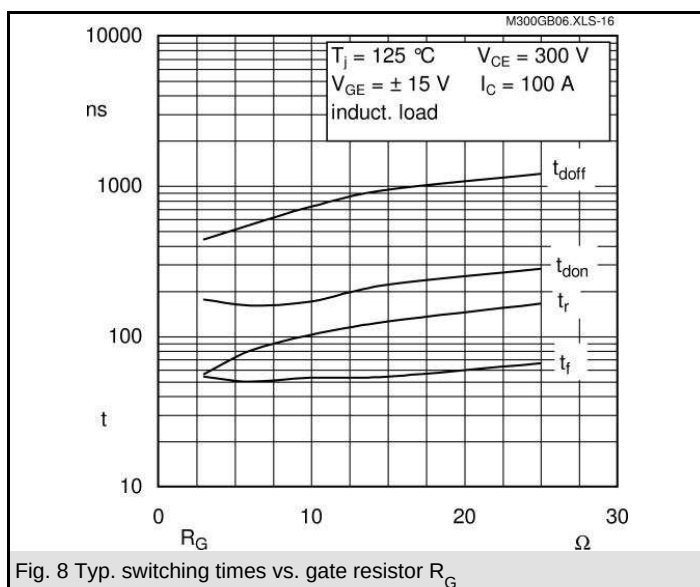
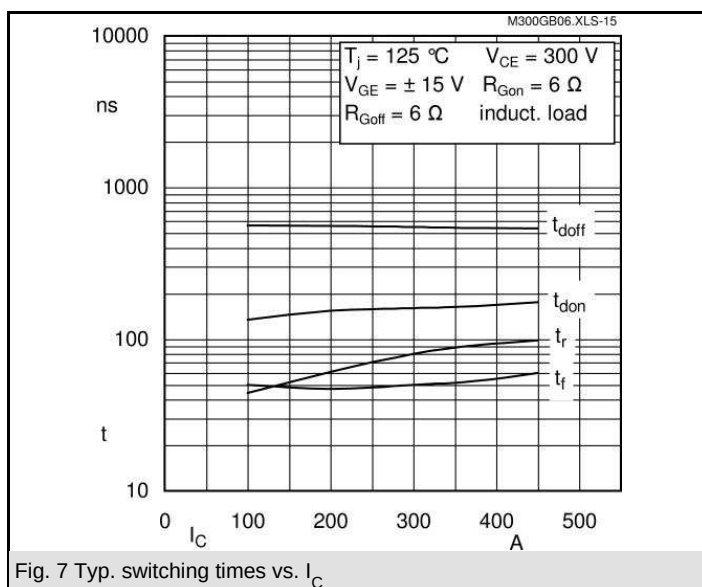
Typical Applications*

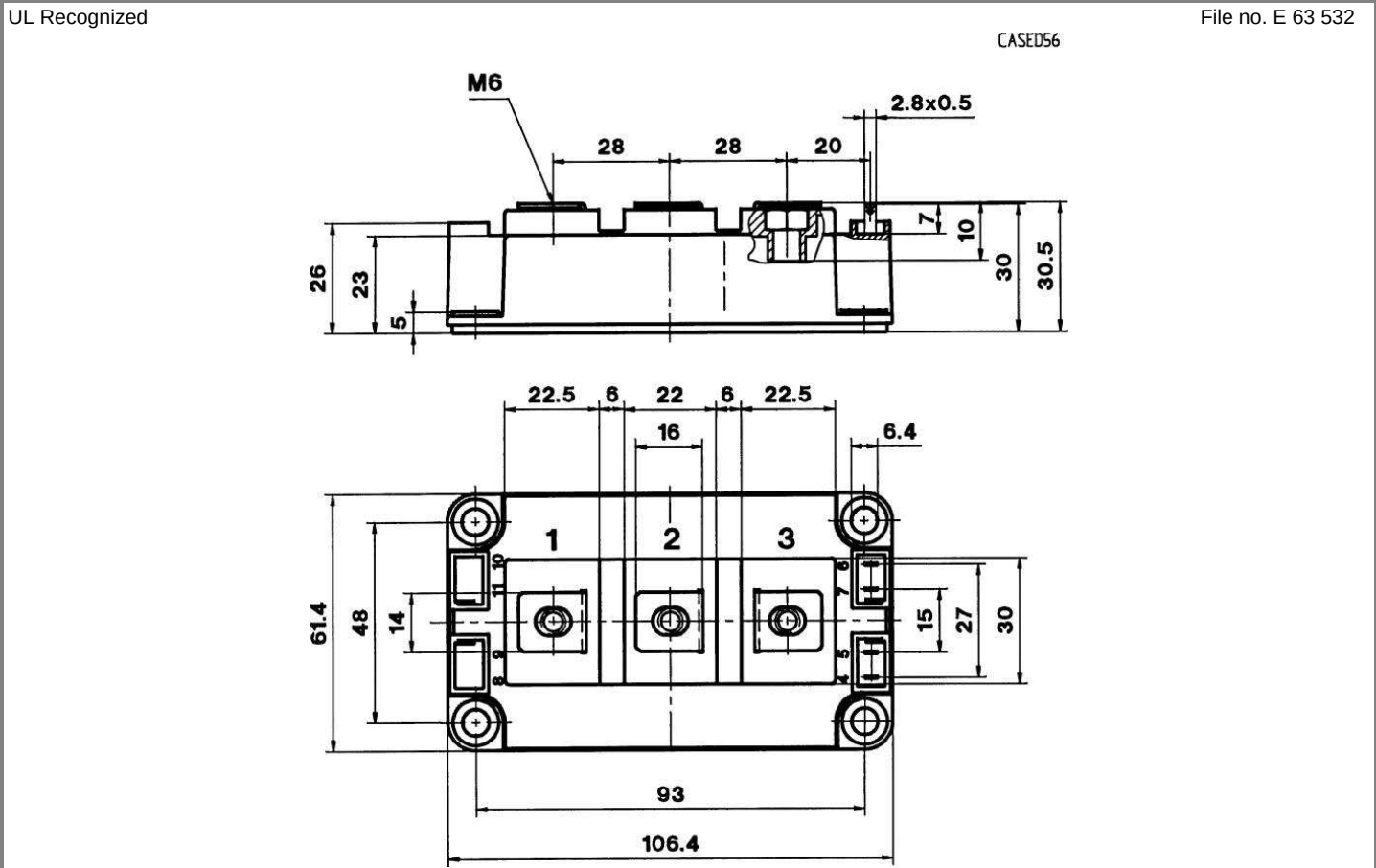
- Switching (not for linear use)
- Switched mode power supplies
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- UPS uninterruptable power supplies
- Welding inverters

Z_{th} Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$			
R_i	$i = 1$	65	mk/W
R_i	$i = 2$	19	mk/W
R_i	$i = 3$	4,7	mk/W
R_i	$i = 4$	1,3	mk/W
τ_{ui}	$i = 1$	0,0518	s
τ_{ui}	$i = 2$	0,0241	s
τ_{ui}	$i = 3$	0,0021	s
τ_{ui}	$i = 4$	0,0001	s
$Z_{th(j-c)D}$			
R_i	$i = 1$	140	mk/W
R_i	$i = 2$	85	mk/W
R_i	$i = 3$	20,55	mk/W
R_i	$i = 4$	4,45	mk/W
τ_{ui}	$i = 1$	0,0613	s
τ_{ui}	$i = 2$	0,0041	s
τ_{ui}	$i = 3$	0,0045	s
τ_{ui}	$i = 4$	0,0003	s

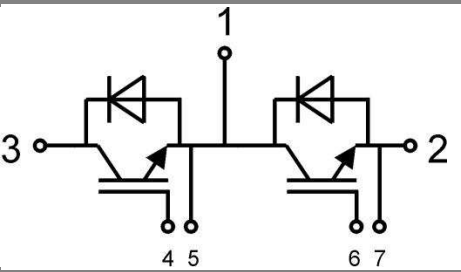




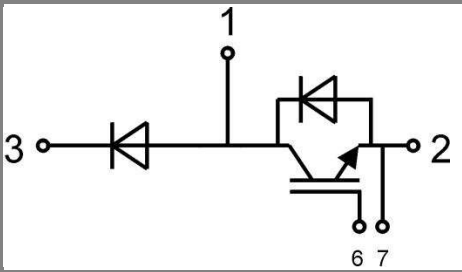




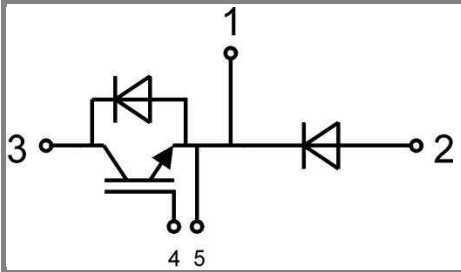
Case D 56



GB Case D 56



GAL Case D 57 (→ D 56)



GAR Case D 58 (→ D 56)